General Purpose SAN, KIBISAN® PN-127H March 30, 2005

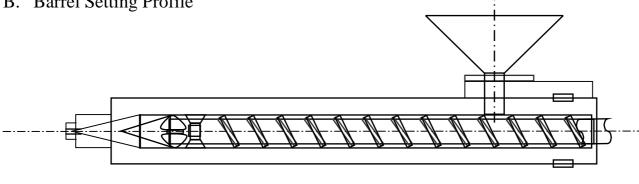
Processing Conditions

Pre-drying $75 \sim 80^{\circ}$ C x $3 \sim 4$ hrs

depending on

- a) Humidity
- b) Ratio of reground resin
- c) Storage conditions

B. Barrel Setting Profile



MAX(°C) 220

220

210

MIN(°C) 200

200

190

40~60 °C C. Mold Temperature

depending on

- a) Thickness
- b) Dimension
- c) Gate and runner system

D. Injection Pressure

 $50 \sim 70 \text{ kg/cm}^2$

Holding Pressure

 $40\sim60 \text{ kg/cm}^2$

Back Pressure

5~15 kg/cm²

NOTE:

- 1. Keep the resin from dust and contamination during handling and production.
- 2. Do not retain the hot melt at the barrel for a long time between injection cycles.
- 3. Temperature setting of manifold system should not exceed 245 °C to avoid melt from degrading.

For further information, please contact your local agent or fax to Chi Mei Technical Services Dept. at 886-6-2665555